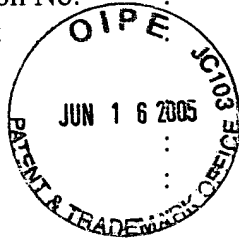


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/762,807
Applicant : Amitay Levi

Filed : January 21, 2004
TC/A.U. : 2818
Examiner : Calvin Lee
Title : **METHOD OF PLANARIZING A SEMICONDUCTOR DIE**



Docket No. : 2102397-992432
Customer No. : 26379

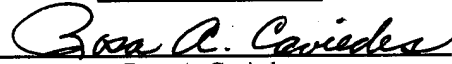
M/S AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as FIRST CLASS MAIL in an envelope addressed to: Mail Stop AMENDMENT, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on:

June 10, 2005



Rosa A. Caviedes

RESPONSE TO OFFICE ACTION OF MAY 17, 2005

Sir:

In response to the Office Action of May 17, 2005, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.